

Mono N-Type Silicon Wafer (G12R)

182.3x210



Geometric Parameter

Side length	Short Side:182.3±0.2mm Long Side:210±0.2mm
Diagonal	272±0.2mm
Thickness	130(+10/-8)μm
Arc length projection	182 Length:4.72±0.57mm 210 Length:4.07±0.52mm



Electrical Properties

Resistivity	0.6-1.6Ω·cm
Minority carrier	≥1000μs
Oxygen content	≤5.75x10 ¹⁷ at/cm ³
Carbon content	≤5x10 ¹⁶ at/cm ³

Material Properties

Growth method	CZ
Orientation	<100>±2°

Surface Performance

TTV	≤20
Warpage	≤40
Line mark	≤13
Edge collapse	Depth≤0.3mm, length≤0.5mm, no more than one places
Cracks and perforations	Invisible by visual inspection
Silicon wafer surface	Clean, free of oil, soap, glue and other residues